



40V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C
40V	$4.0 \text{m}\Omega$ @ $V_{GS} = 10V$	220A

Description

This new generation Enhancement Mode MOSFET is designed to minimize R_{DS(ON)} and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

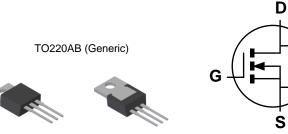
- Motor Control
- Backlighting
- DC-DC Converters
- **Power Management Functions**

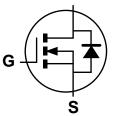
Features

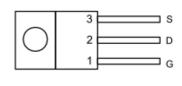
- Rated to +175°C Ideal for High Ambient Temperature Environments
- Low Input Capacitance
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: TO220AB (Generic)
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (93)
- Terminal Connections: See Diagram Below
- Weight: 1.85 grams (Approximate)







Top View

Bottom View

Equivalent Circuit

Top View Pin Out Configuration

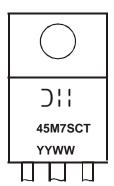
Ordering Information (Note 4)

Part Number		Case	Packaging	
	DMNH45M7SCT	TO220AB (Generic)	50 Pieces/Tube	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



) | = Manufacturer's Marking 45M7SCT = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week (01 to 53)

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Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	40	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current V _{GS} = 10V	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	ID	220 155	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	200	Α		
Maximum Continuous Body Diode Forward Current (Note 5)			Is	2.9	Α
Avalanche Current (Note 6) L=0.1mH			I _{AS}	43	Α
Avalanche Energy (Note 6) L=0.1mH			Eas	92	mJ

Thermal Characteristics

Characteristic			Value	Unit	
Dawar Dissination	$T_C = +25^{\circ}C$	7	240	14/	
Power Dissipation	$T_C = +70^{\circ}C$		96	W	
Thermal Resistance, Junction to Case		$R_{\theta JC}$	0.52	°C/W	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C	

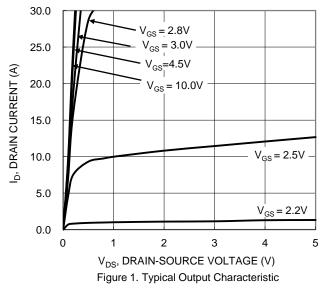
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 32V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	022		I	I	ı	- , , , ,	
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	3.4	6.0	mΩ	V _{GS} = 10V, I _D = 20A	
Diode Forward Voltage	V _{SD}	_	_	1.2	V	$V_{GS} = 0V$, $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)	•		•	•	•		
Input Capacitance	C _{iss}		4043	_		$V_{DS} = 20V, V_{GS} = 0V$ f = 1.0MHz	
Output Capacitance	Coss	_	694	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	272	_	<u></u>		
Gate Resistance	R_g	_	1.83	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg	_	64.7	_		V _{DD} = 20V, I _D = 20A	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	31.6	_			
Gate-Source Charge	Qgs	_	7.7	_	nC		
Gate-Drain Charge	Q_{gd}	_	13.1	_			
Turn-On Delay Time	t _{D(ON)}	_	5.8	_		$V_{DD} = 20V, V_{GS} = 10V,$ $R_g = 1\Omega, I_D = 20A$	
Turn-On Rise Time	t _R	_	11.7	_			
Turn-Off Delay Time	t _{D(OFF)}	_	28.9	_	ns		
Turn-Off Fall Time	t _F	_	6.6	_			
Reverse Recovery Time	t _{RR}	_	28.4	_	ns	154 11/11 1004/	
Reverse Recovery Charge	Q _{RR}	_	21.4	_	nC	$I_F = 15A$, di/dt = 100A/ μ s	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. 6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_{J} = +25°C. 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing. Notes:

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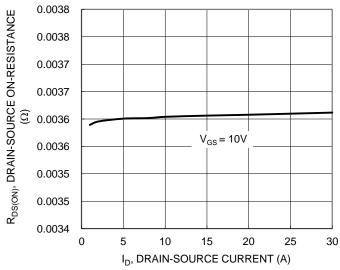


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

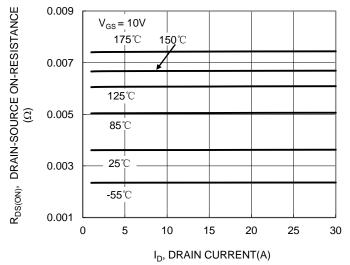
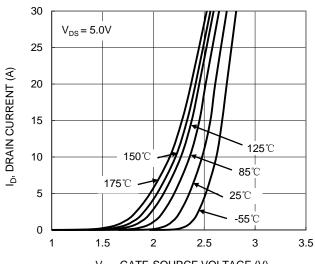


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

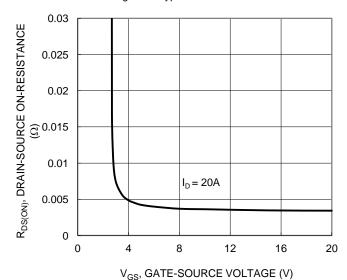


Figure 4. Typical Transfer Characteristic

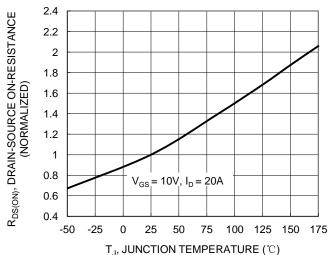


Figure 6. On-Resistance Variation with Temperature



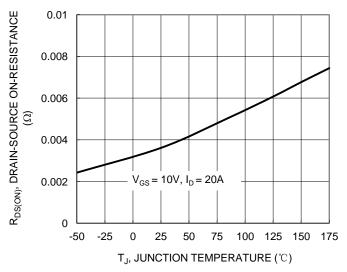


Figure 7. On-Resistance Variation with Temperature

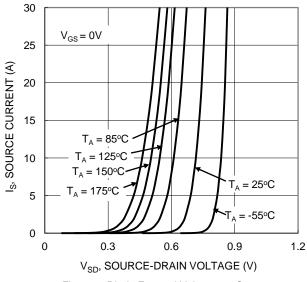


Figure 9. Diode Forward Voltage vs. Current

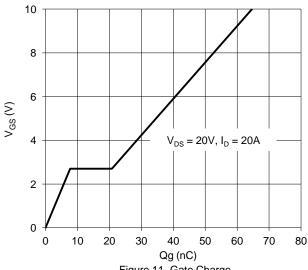


Figure 11. Gate Charge

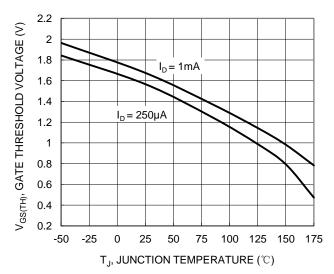


Figure 8.Gate Threshold Variation vs. Junction Temperature

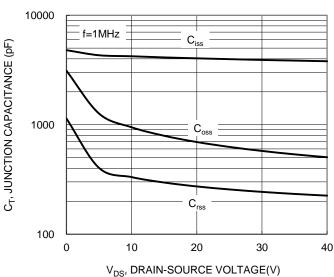


Figure 10. Typical Junction Capacitance

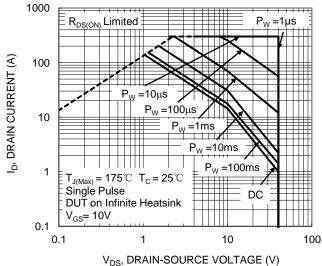
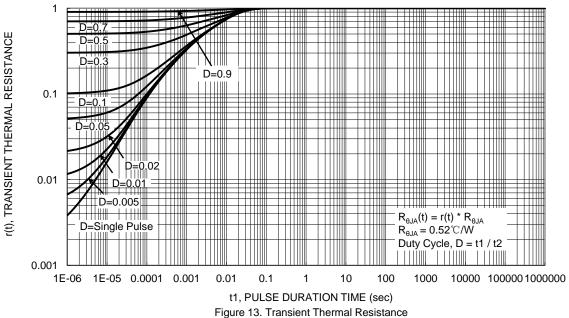


Figure 12. SOA, Safe Operation Area



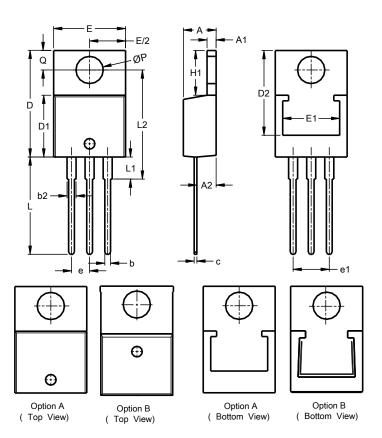


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Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO220AB (Generic)



TO220AB (Generic)					
Dim	Min	Max	Тур		
Α	3.56	4.82	-		
A1	0.51	1.39	-		
A2	2.04	2.92	-		
b	0.39	1.01	0.81		
b2	1.15	1.77	1.24		
С	0.356	0.61	-		
ם	14.22	16.51	ı		
D1	8.39	9.01	-		
D2	11.45	12.87	-		
е	-	-	2.54		
e1	-	-	5.08		
Е	9.66	10.66	1		
E1	6.86	8.89	ı		
H1	5.85	6.85	-		
L	12.70	14.73	-		
L1	-	4.42	-		
L2	15.80	17.51	16.00		
Р	3.54	4.08	-		
ø	2.54	3.42	-		
All Dimensions in mm					



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